

DATA SHEET

# SKY67021-396LF: 0.6 to 1.2 GHz High-Linearity, Active-Bias Low-Noise Amplifier

## Applications

- GSM, CDMA, WCDMA, TD-SCDMA cellular infrastructure
- Ultra low-noise systems
- Balanced, single-ended low-noise amplifier designs

## Features

- Extended operating temperature range: -40 °C to +100 °C
- Low noise figure: 0.6 dB @ 0.9 GHz
- Excellent IIP3 performance: +22.5 dBm @ 0.9 GHz
- Gain: 17.5 dB @ 0.9 GHz
- Adjustable supply current
- Integrated enable circuitry
- Temperature and process-stable active bias
- Miniature DFN (8-pin, 2 x 2 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

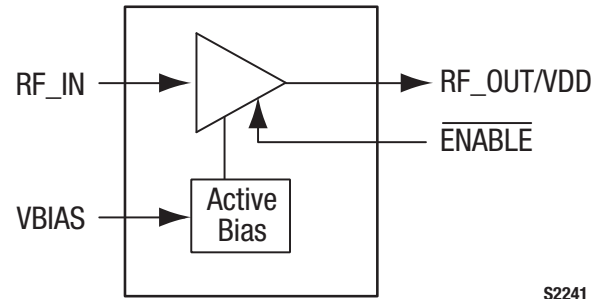


Figure 1. SKY67021-396LF Block Diagram

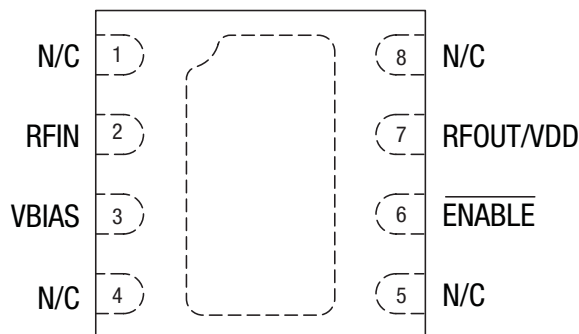
## Description

The SKY67021-396LF is GaAs, pHEMT low-noise amplifier (LNA) with an active bias and high-linearity performance. The advanced GaAs pHEMT enhancement mode process provides good return loss, low noise, and high-linearity performance.

The internal active bias circuitry provides stable performance over temperature and process variation. The device offers the ability to externally adjust supply current and gain. Supply voltage is applied to the RFOUT/VDD pin through an RF choke inductor. Pin 3 (VBIAS) should be connected to RFOUT/VDD through an external resistor to control the supply current. The RFIN and RFOUT/VDD pins should be DC blocked to ensure proper operation.

The SKY67021-396LF operates in the frequency range of 0.6 to 1.2 GHz. For higher frequency operation, the pin-compatible SKY67022-396LF or SKY67023-396LF should be used.

The LNA is manufactured in a compact, 2 x 2 mm, 8-pin Dual Flat No-Lead (DFN) package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.



S2240

Figure 2. SKY67021-396LF Pinout (Top View)

**Table 1. SKY67021-396LF Signal Descriptions**

Pin	Name	Description	Pin	Name	Description
1	N/C	No connection. May be connected to ground with no change in performance.	5	N/C	No connection. May be connected to ground with no change in performance.
2	RFIN	RF input. DC blocking capacitor required.	6	ENABLE	Enable pin. Active “low” (0 V) = amplifier on state.
3	VBIAS	Bias for 1 <sup>st</sup> stage amplifier. External resistor sets current consumption.	7	RFOUT/VDD	RF output. Apply VDD through RF choke inductor. DC blocking capacitor required.
4	N/C	No connection. May be connected to ground with no change in performance.	8	N/C	No connection. May be connected to ground with no change in performance.

**Table 2. SKY67021-396LF Absolute Maximum Ratings<sup>1</sup>**

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage	V <sub>DD</sub>		5.0	5.5	V
Supply current	I <sub>DD</sub>			150	mA
RF input power	P <sub>IN</sub>			+20	dBm
Channel temperature	T <sub>CH</sub>			+150	°C
Thermal resistance <sup>2</sup>	Θ <sub>JC</sub>		56.4		°C/W
Storage temperature	T <sub>STG</sub>	-65	+25	+150	°C
Operating temperature	T <sub>A</sub>	-55	+25	+100	°C
Electrostatic discharge:	ESD				
Charged Device Model (CDM), Class 4		1000			V
Human Body Model (HBM), Class 1A		250			V
Machine Model (MM), Class A		30			V

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

<sup>2</sup> Thermal resistance = 56.4 °C/W @ 5 V bias.

**ESD HANDLING:** *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

### Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY67021-396LF are provided in Table 2. Electrical specifications are provided in Table 3.

Typical performance characteristics of the SKY67021-396LF are illustrated in Figures 3 through 28.

Table 4 provides noise source pull information versus frequency.

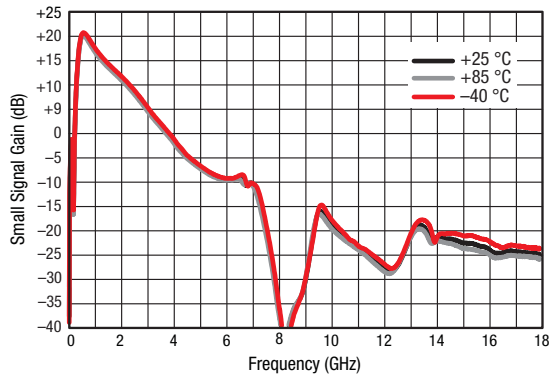
**Table 3. SKY67021-396LF Electrical Specifications<sup>1,2</sup>****(V<sub>DD</sub> = 5 V, I<sub>DD</sub> = 100 mA, T<sub>A</sub> = +25 °C, P<sub>IN</sub> = -20 dBm, Characteristic Impedance [Z<sub>0</sub>] = 50 Ω, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
<b>RF Specifications</b>						
Noise figure <sup>3</sup>	NF	@ 0.9 GHz		0.60	0.75	dB
Small signal gain	IS21I	@ 0.9 GHz	16.5	17.5	18.5	dB
Input return loss	IS11I	@ 0.9 GHz	11.0	12.5		dB
Output return loss	IS22I	@ 0.9 GHz	8.0	9.5		dB
Reverse isolation	IS12I	@ 0.9 GHz	27	29		dB
Third order input intercept point	IIP3	@ 0.9 GHz, Δf = 1 MHz, P <sub>IN</sub> = -20 dBm/tone	+20.8	+22.5		dBm
Third order output intercept point	OIP3	@ 0.9 GHz, Δf = 1 MHz, P <sub>IN</sub> = -20 dBm/tone	+38.3	+40.0		dBm
1 dB input compression point	IP1dB	@ 0.9 GHz	+3.4	+5.2		dBm
1 dB output compression point	OP1dB	@ 0.9 GHz	+20.0	+21.7		dBm
Stability <sup>4</sup>	μ, μ1	Up to 18 GHz, -40 °C to +85 °C		> 1		-
<b>DC Specifications</b>						
Supply voltage	V <sub>DD</sub>			5.0		V
Quiescent supply current	I <sub>DD</sub>	Set with external resistor	85	100	115	mA
Amplifier enable off current (logic "high")	I <sub>EN</sub>		700	900	1100	μA
Enable voltage:	V <sub>ENABLE</sub>					
Gain mode				0	0.2	V
Power-down mode				1.5	5.5	V
Enable rise time	T <sub>R</sub>	@ 0.9 GHz		250	500	ns
Enable fall time	T <sub>F</sub>	@ 0.9 GHz		250	500	ns

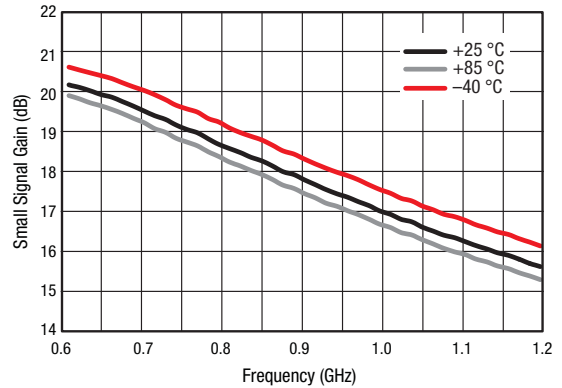
<sup>1</sup> Performance is guaranteed only under the conditions listed in this Table.<sup>2</sup> Circuit topology optimized for balanced configuration with best IIP3 and NF performance.<sup>3</sup> Loss from the input SMA connector and Evaluation Board up to component M1 has not been de-embedded from the NF measurement.<sup>4</sup> Applies to typical application circuit and components shown in Figure 31.

### Typical Performance Characteristics

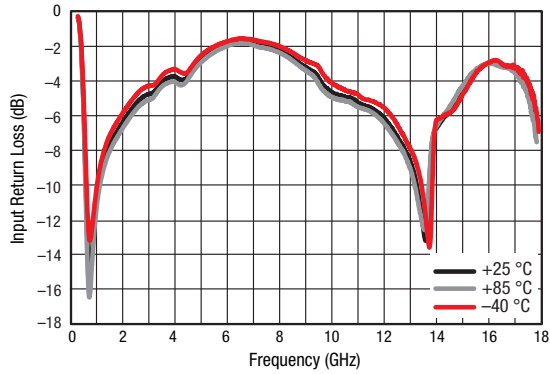
(VDD = 5 V, Idd = 100 mA, TA = +25 °C, PIN = -20 dBm, Characteristic Impedance [Zo] = 50 Ω, Unless Otherwise Noted)



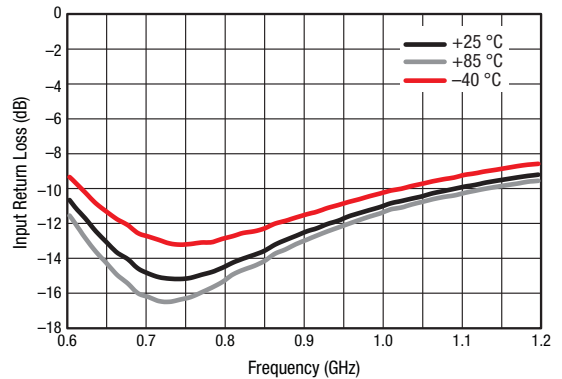
**Figure 3. Broadband Gain Response vs Frequency Over Temperature**



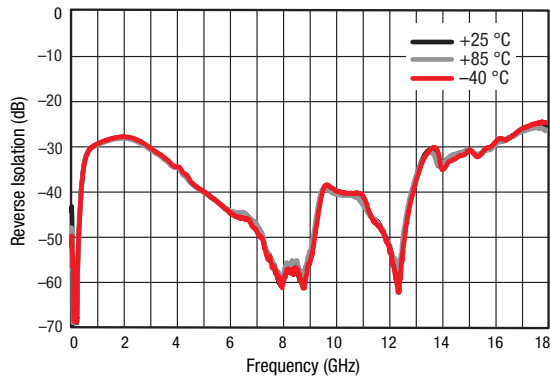
**Figure 4. Narrowband Gain Response vs Frequency Over Temperature**



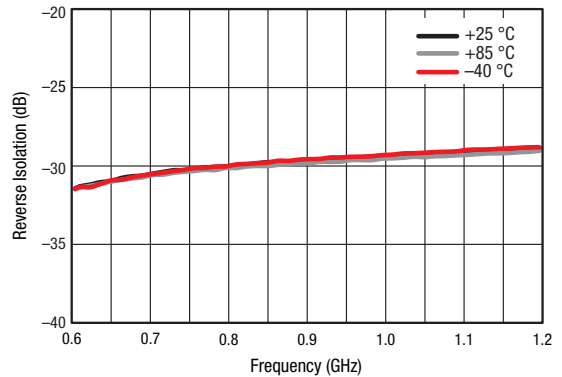
**Figure 5. Broadband Input Return Loss vs Frequency Over Temperature**



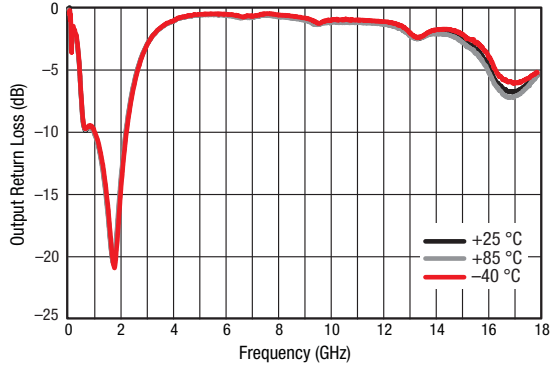
**Figure 6. Narrowband Input Return Loss vs Frequency Over Temperature**



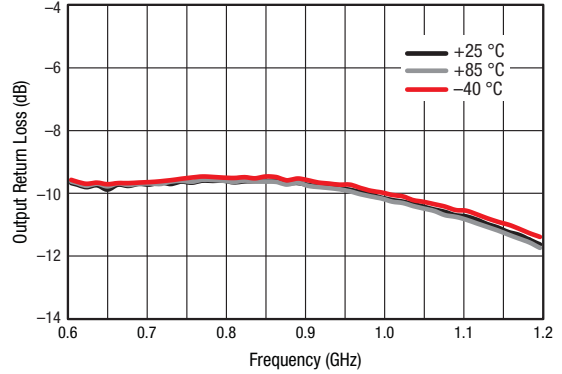
**Figure 7. Broadband Reverse Isolation vs Frequency Over Temperature**



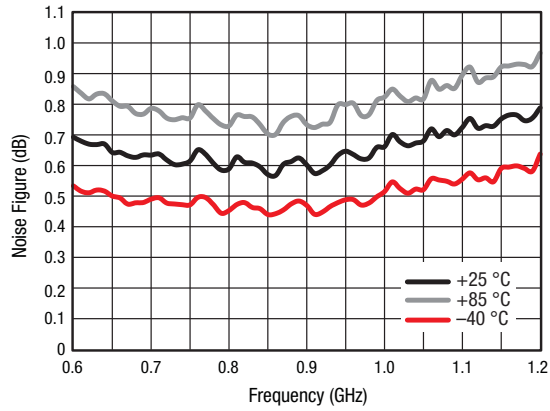
**Figure 8. Narrowband Reverse Isolation vs Frequency Over Temperature**



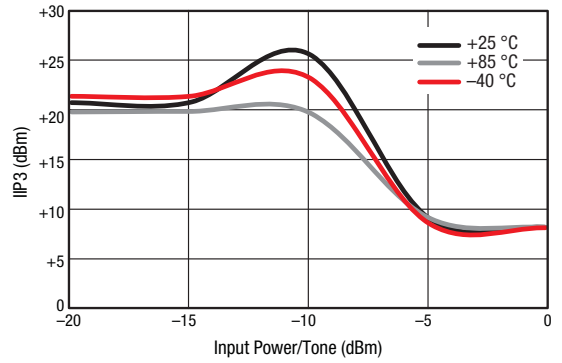
**Figure 9. Broadband Output Return Loss vs Frequency Over Temperature**



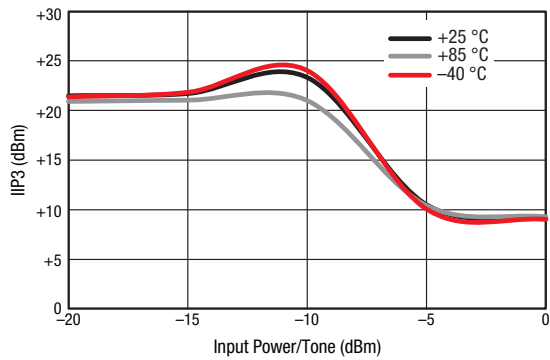
**Figure 10. Narrowband Output Return Loss vs Frequency Over Temperature**



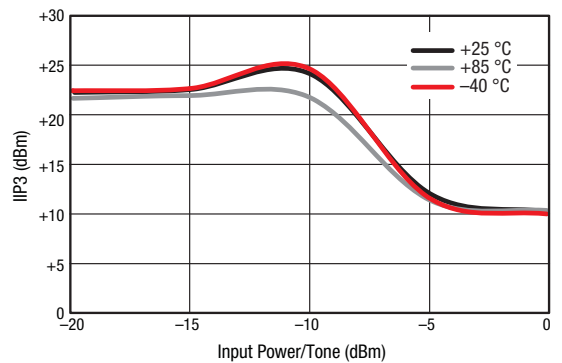
**Figure 11. Noise Figure vs Frequency Over Temperature**



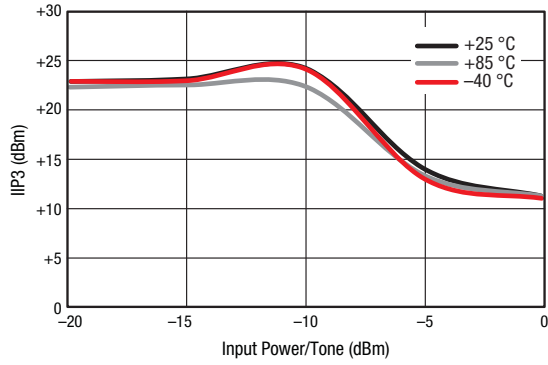
**Figure 12. IIP3 vs Input Power Over Temperature @ 600 MHz ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



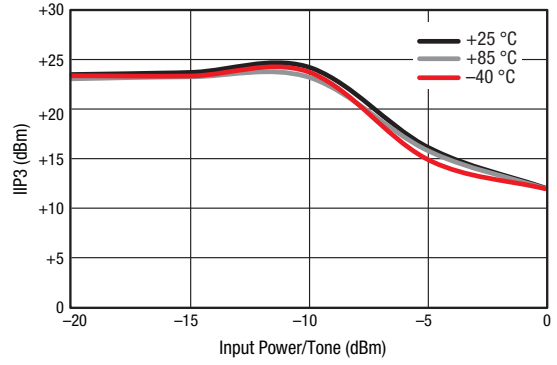
**Figure 13. IIP3 vs Input Power Over Temperature @ 700 MHz ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



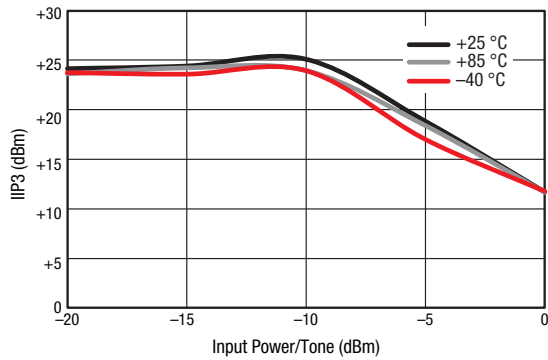
**Figure 14. IIP3 vs Input Power Over Temperature @ 800 MHz ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



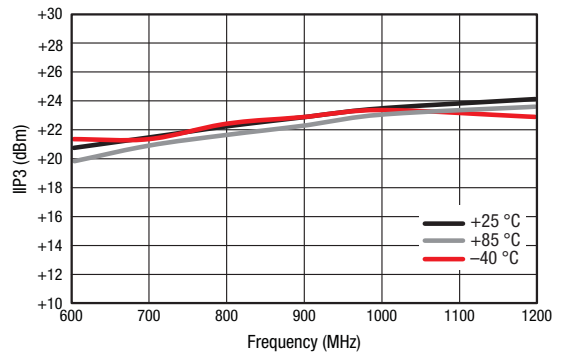
**Figure 15. IIP3 vs Input Power Over Temperature @ 900 MHz ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



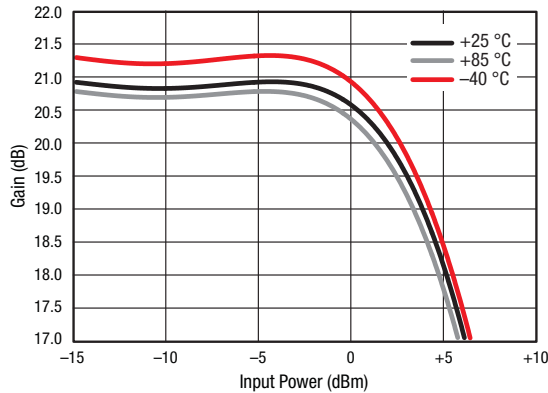
**Figure 16. IIP3 vs Input Power Over Temperature @ 1000 MHz ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



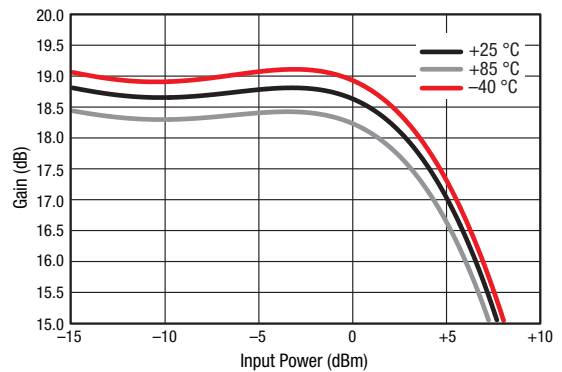
**Figure 17. IIP3 vs Input Power Over Temperature @ 1200 MHz ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



**Figure 18. IIP3 vs Frequency Over Temperature ( $P_{IN} = -20$  dBm, Tone Spacing = 1 MHz)**



**Figure 19. Gain vs Input Power Over Temperature @ 600 MHz**



**Figure 20. Gain vs Input Power Over Temperature @ 700 MHz**

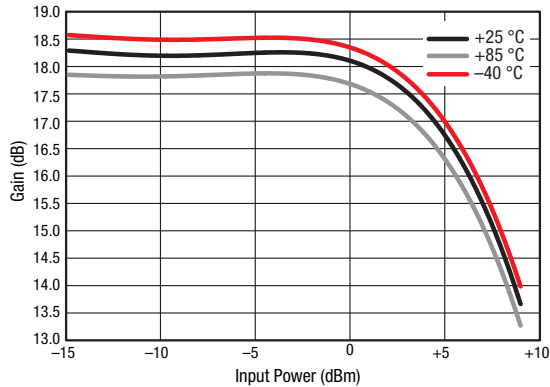


Figure 21. Gain vs Input Power Over Temperature @ 800 MHz

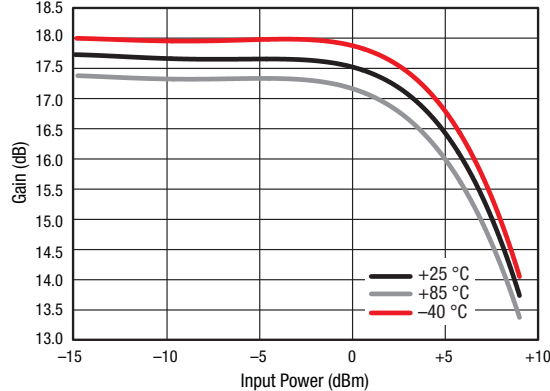


Figure 22. Gain vs Input Power Over Temperature @ 900 MHz

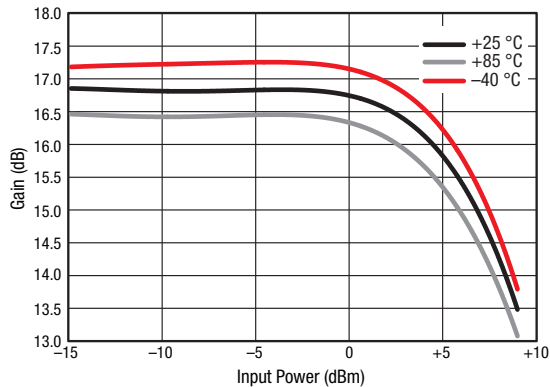


Figure 23. Gain vs Input Power Over Temperature @ 1000 MHz

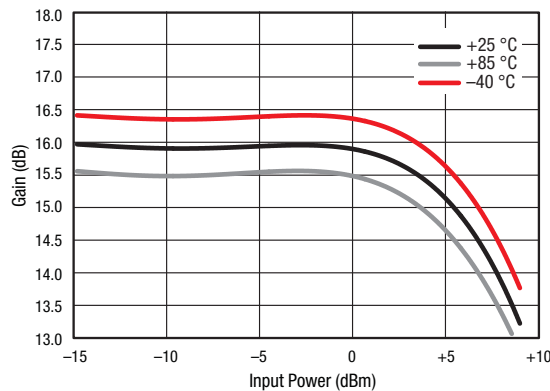


Figure 24. Gain vs Input Power Over Temperature @ 1200 MHz

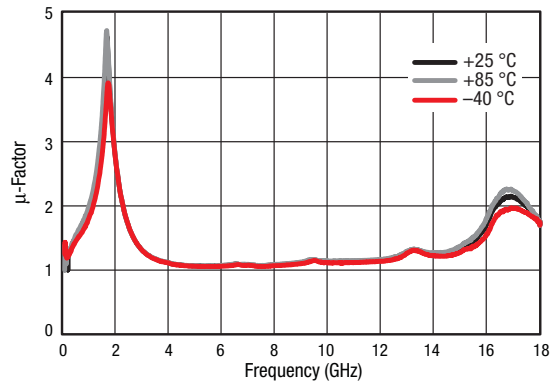


Figure 25. Stability Factor ( $\mu$ ) vs Frequency Over Temperature

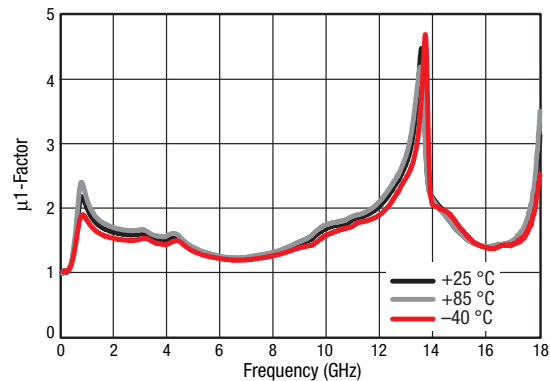


Figure 26. Stability Factor ( $\mu_1$ ) vs Frequency Over Temperature

Swept F1 Load Gamma Pull  
Freq = 0.9000 GHz  
ΓSource: 0.2393< 58.72

Gt max = 18.76 dB  
at 0.4247< 151.74  
5 contours, 1.00 dB step  
(14.00 to 18.00 dB)  
Ip3 max = 39.52 dBm  
at 0.4811< -174.59  
5 contours, 0.50 dBm step  
(37.50 to 39.50 dBm)  
Specs: OFF

Label:  
SKY67021\_OIP3\_900MHz\_5V\_100mA

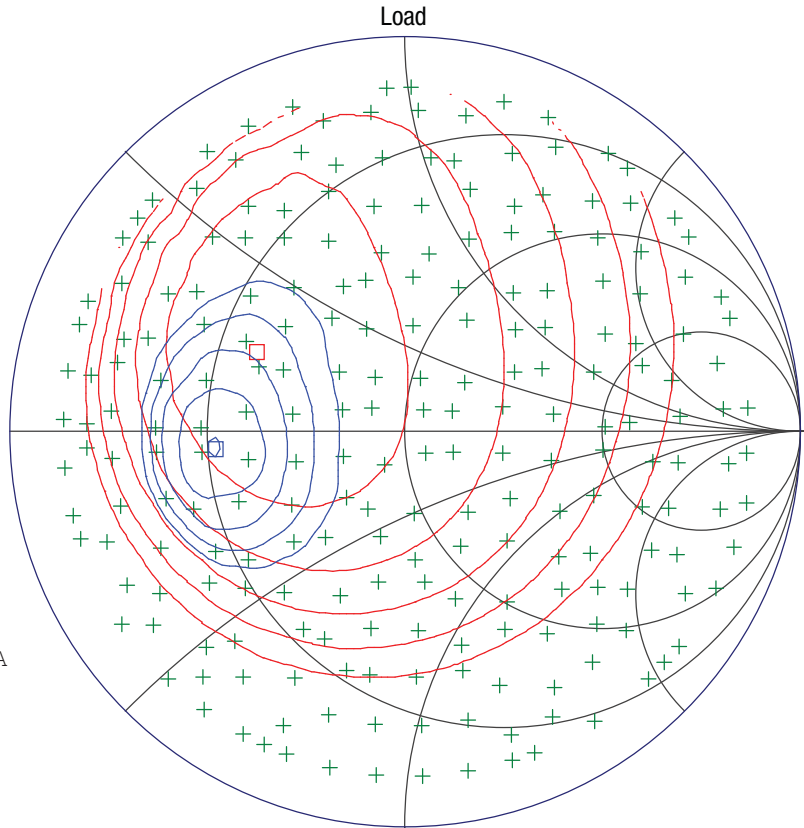


Figure 27. Load Pull, @ 5 V, 900 MHz, 100 mA



**Table 4. Noise Parameters vs Frequency @ 5.0 V and 100 mA**

Frequency (GHz)	Minimum Noise Figure (F <sub>MIN</sub> ) (dB)	Noise Resistance (R <sub>N</sub> ) (Ω)	Γ <sub>opt</sub>		Associated Gain (dB)	Maximum Gain (G <sub>MAX</sub> ) (dB)
			Magnitude	Phase		
0.80	0.5571	0.0600	0.1286	129.21	18.8608	19.7254
0.84	0.3977	0.1264	0.1201	72.63	18.8469	19.3559
0.89	0.543	0.0414	0.1575	111.37	18.1270	18.9171
1.20	0.7077	0.0667	0.1636	107.57	15.8561	16.6599
1.42	0.8033	0.0777	0.1466	110.34	14.5550	15.4004
1.52	0.8732	0.0767	0.1751	130.29	13.8350	14.8953
1.76	1.0127	0.1047	0.1240	122.01	12.8532	13.8256
1.84	1.1337	0.1062	0.1113	147.04	12.3242	13.5113
1.92	1.1686	0.1132	0.1137	134.44	12.1251	13.2098
1.98	1.232	0.1021	0.1260	163.51	11.6427	12.9939
2.00	1.3361	0.2648	0.1212	74.78	12.1585	12.9206
2.38	1.5989	0.1143	0.1302	158.37	10.4524	11.7369
2.52	1.6619	0.1667	0.1109	156.50	10.1114	11.3724
2.60	1.7366	0.1817	0.0974	156.70	9.9104	11.1835
2.70	1.6845	0.1032	0.1529	-165.66	9.2704	10.9525
3.00	2.1342	0.1874	0.0978	171.43	8.9475	10.3251
3.60	2.6314	0.2626	0.0816	172.61	6.9070	8.3274
4.00	2.9366	0.3237	0.1187	-160.48	7.3181	8.8760
5.00	3.7549	0.4659	0.2157	-156.72	6.3847	8.3182
6.00	4.5836	0.4105	0.3645	-149.11	5.9685	8.3084
7.00	5.4265	0.7168	0.3627	-157.54	5.3432	8.5428

## Evaluation Board Description

The SKY67021-396LF Evaluation Board is used to test the performance of the SKY67021-396LF LNA. An assembly drawing for the Evaluation Board is shown in Figure 28. The layer detail is provided in Figure 29. An Evaluation Board schematic diagram is provided in Figure 30. Table 5 provides the Bill of Materials (BOM) list for Evaluation Board components.

## Package Dimensions

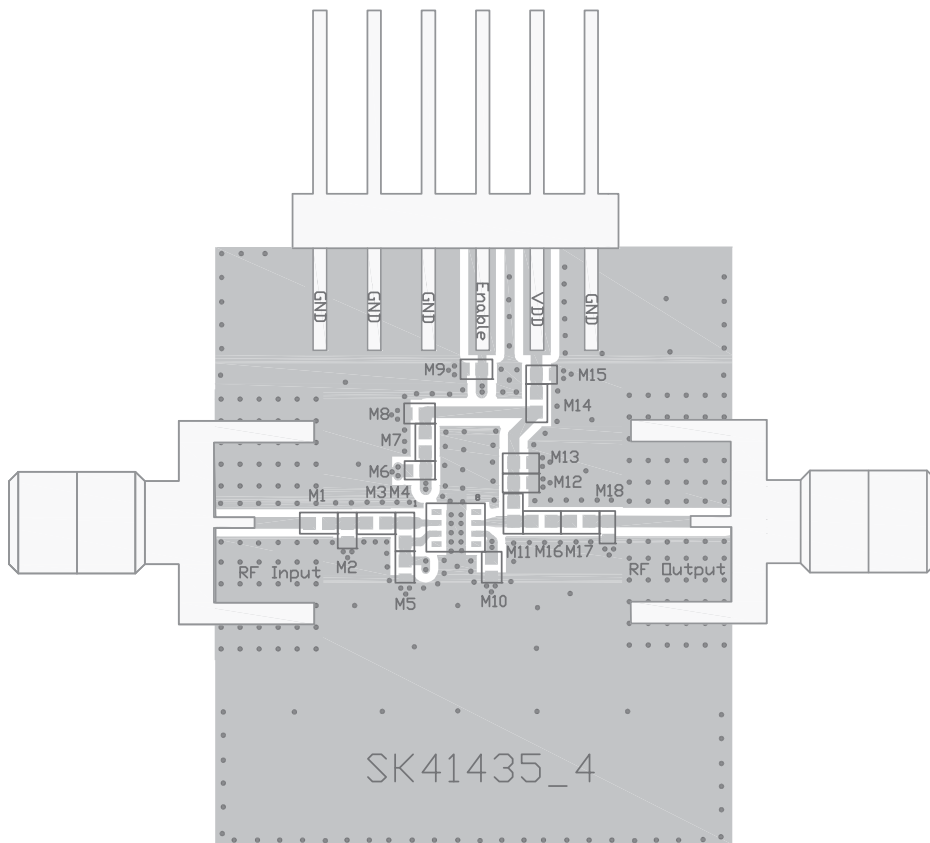
The PCB layout footprint for the SKY67021-396LF is provided in Figure 31. Typical part markings are shown in Figure 32. Package dimensions are shown in Figure 33, and tape and reel dimensions are provided in Figure 34.

## Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY67021-396LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



S2528

Figure 28. SKY67021-396LF Evaluation Board Assembly Diagram

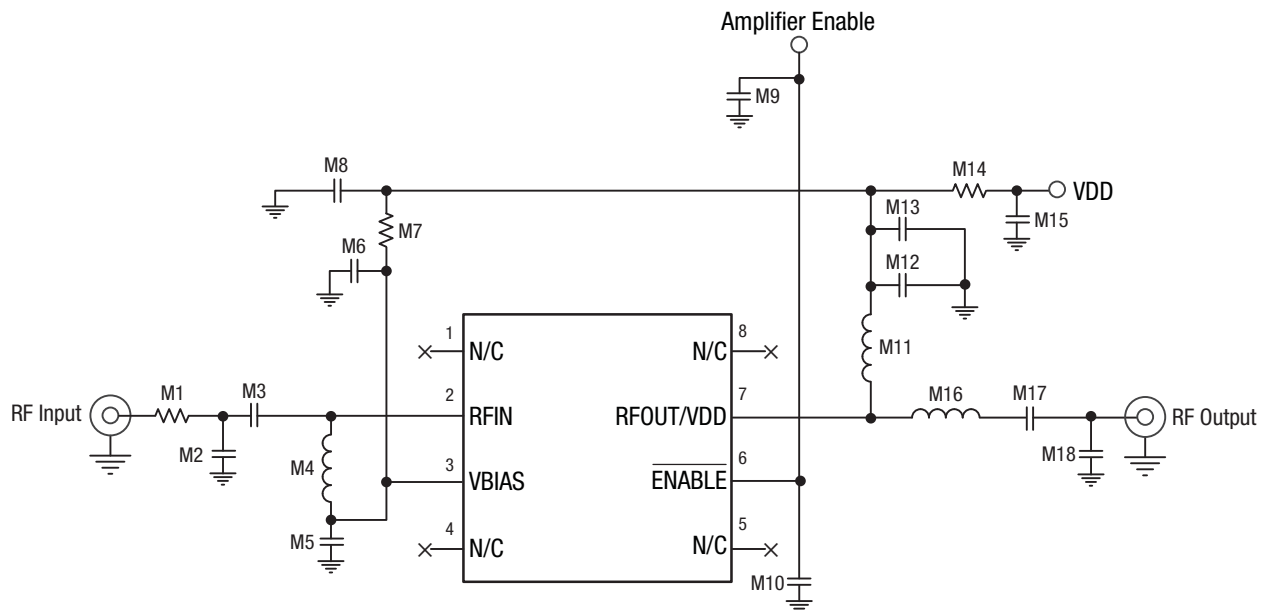
Cross Section	Name	Thickness (mm)	Material
	MSK-NS		
	TRA-NS	0.03556	Cu foil
	Laminate	0.254 ± 0.152	Rogers 4350B
	TRA-2	0.0178	Cu foil
	Laminate	0.889 nom.	FR4 Prepreg (Note 1)
	TRA-3	0.0178	Cu foil
	Laminate	0.254 ± 0.152	FR4 Core
	TRA-FS	0.0178	Cu foil
	MSK-PS		

Note 1: Adjust this thickness to meet total thickness goal.

General Notes:  
 Material: Rogers R04350,  $\epsilon_r = 3.66$   
 Layer 1 thickness: 0.254 mm  
 Overall board thickness: 1.575 mm  
 50  $\Omega$  transmission line width: 0.522 mm  
 Coplanar ground spacing: 0.394 mm  
 Via diameter: 0.254 mm

S2530

Figure 29. Layer Detail Physical Characteristics

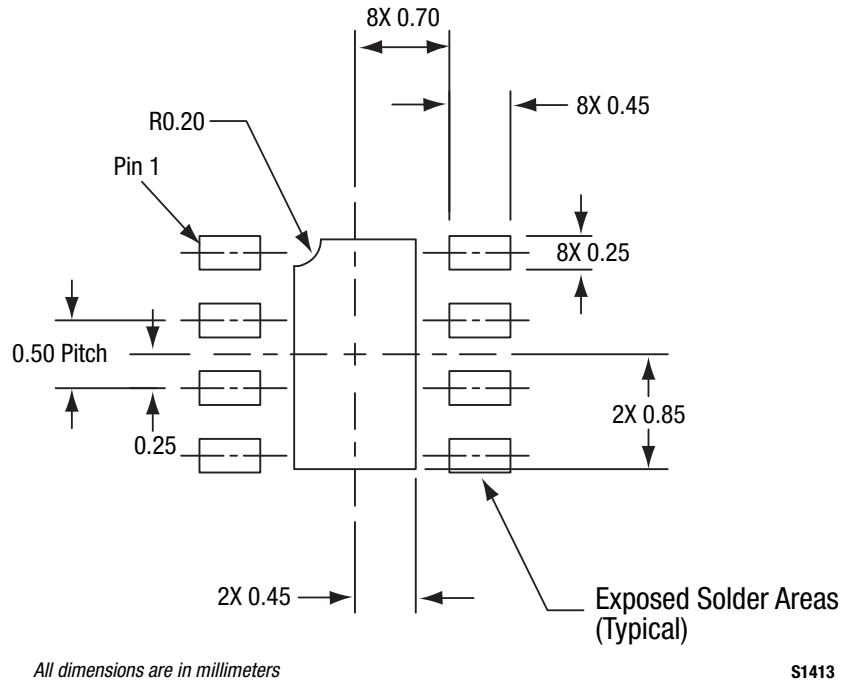


S2254a

Figure 30. SKY67021-396LF Evaluation Board Schematic

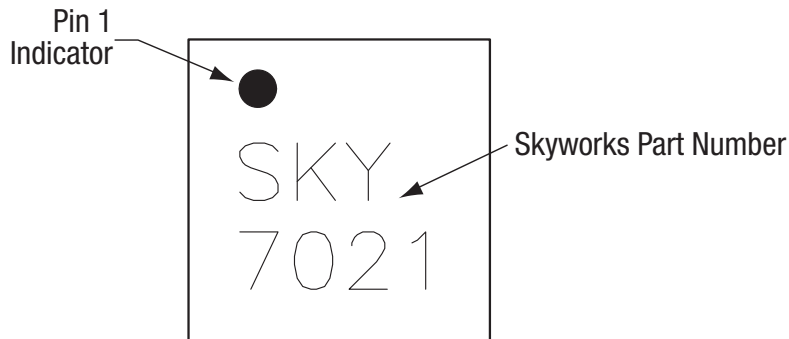
Table 5. SKY67021-396LF Evaluation Board Bill of Materials

Component	Type	Size	Value (5 V @ 100 mA)	Manufacturer	Mfr Part Number
M1	Resistor	0402	0 Ω	Panasonic	ERJ-2GEOR00X
M2	DNI	0402	-	-	-
M3	Capacitor	0402	6 pF	Murata	GJM1555C1H6R0CB01
M4	Inductor	0402	12 nH	Coilcraft	0402HP-12NX_GLU
M5	Capacitor	0402	68 pF	Murata	GRM1555C1H680JZ01
M6	DNI	0402	-	-	-
M7	Resistor	0402	3.6 kΩ	Panasonic	ERJ-2GEJ362X
M8	Capacitor	0402	0.1 μF	Murata	GRM155R71A104KA01
M9	Capacitor	0402	1000 pF	Murata	GRM1555C1H102JA01
M10	DNI	0402	-	-	-
M11	Inductor	0402	27 nH	Murata	LQG15HN27NJ02D
M12	Capacitor	0402	10 pF	Murata	GRM1555C1H100JZ01D
M13	Capacitor	0402	1000 pF	Murata	GRM1555C1H102JA01
M14	Resistor	0402	0 Ω	Panasonic	ERJ-2GEOR00X
M15	DNI	0402	-	-	-
M16	Inductor	0402	4.3 nH	Murata	LQG15HN4N3S02D
M17	Capacitor	0402	82 pF	Murata	GRM1555C1H820JA01
M18	DNI	0402	-	-	-

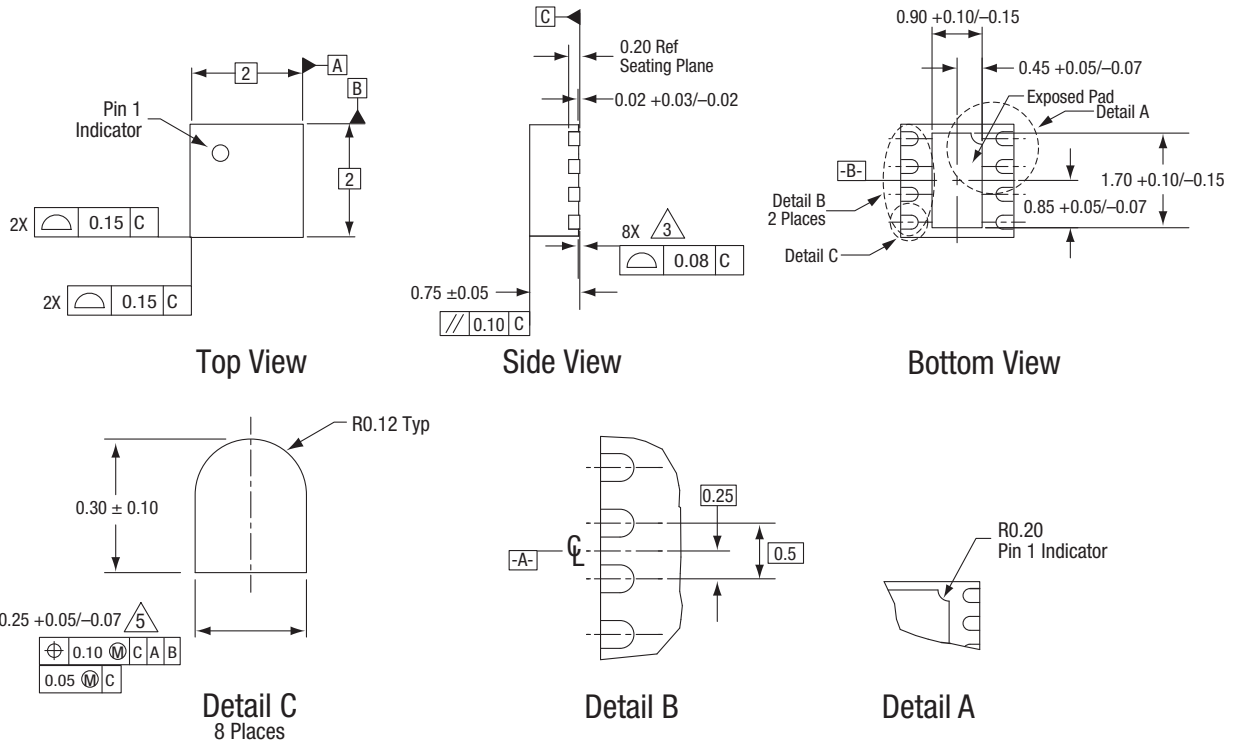


S1413

**Figure 31. SKY67021-396LF PCB Layout Footprint (Top View)**



**Figure 32. Typical Part Markings (Top View)**

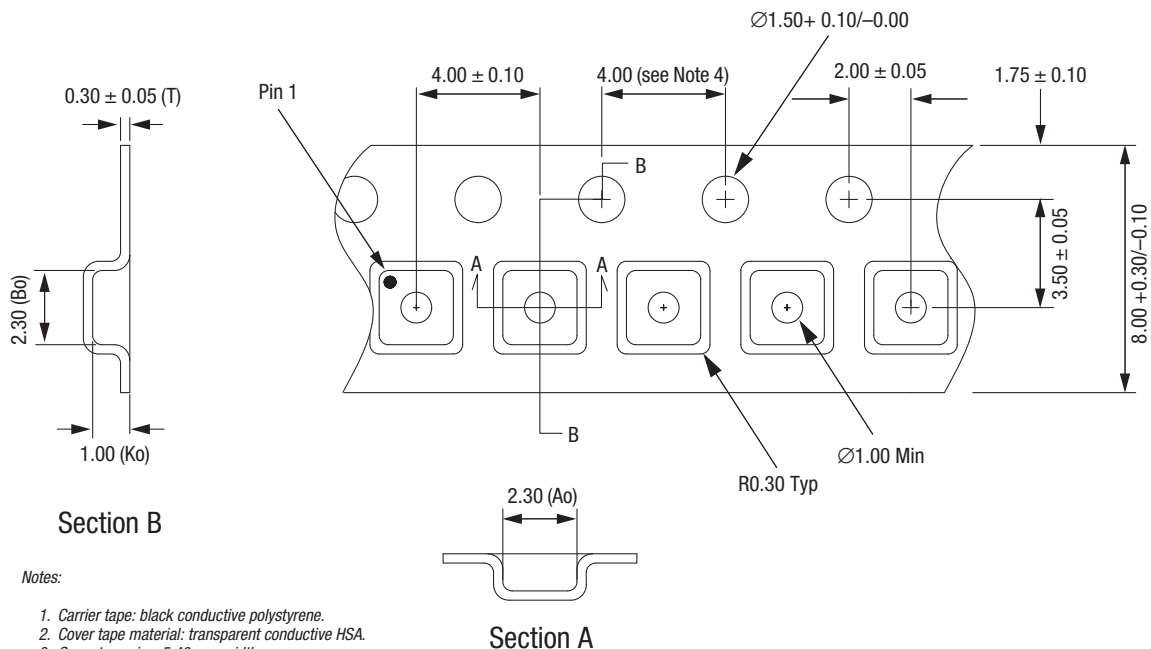


Notes:

1. All measurements are in millimeters.
2. Dimensions and tolerances according to ASME Y14.5M-1994.
3. Coplanarity applies to the exposed heat sink ground pad as well as the terminals.
4. Plating requirement per source control drawing (SCD) 2504.
5. Dimension applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.

S1945

Figure 33. SKY67021-396LF Package Dimensions



Notes:

1. Carrier tape: black conductive polystyrene.
2. Cover tape material: transparent conductive HSA.
3. Cover tape size: 5.40 mm width.
4. Ten sprocket hole pitch cumulative tolerance = ±0.20 mm.
5. ESD surface resistivity is  $\leq 1 \times 10^9$  Ohms/square per EIA, JEDEC tape and reel specification.
6. Ao and Bo measurement point to be 0.30 mm from bottom pocket.
7. All measurements are in millimeters.

S1601

Figure 34. SKY67021-396LF Tape and Reel Dimensions

## Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY67021-396LF LNA	SKY67021-396LF	SKY67021-396LF-EVB

Copyright © 2013, 2016-2017 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks and the Skyworks symbol are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at [www.skyworksinc.com](http://www.skyworksinc.com), are incorporated by reference.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [RF Amplifier](#) category:*

*Click to view products by [Skyworks](#) manufacturer:*

Other Similar products are found below :

[A82-1](#) [BGA622H6820XTSA1](#) [BGA 728L7 E6327](#) [BGB719N7ESDE6327XTMA1](#) [HMC397-SX](#) [HMC405](#) [HMC561-SX](#) [HMC8120-SX](#)  
[HMC8121-SX](#) [HMC-ALH382-SX](#) [HMC-ALH476-SX](#) [SE2433T-R](#) [SMA3101-TL-E](#) [SMA39](#) [A66-1](#) [A66-3](#) [A67-1](#) [A81-2](#) [LX5535LQ](#)  
[LX5540LL](#) [MAAM02350](#) [HMC3653LP3BETR](#) [HMC549MS8GETR](#) [HMC-ALH435-SX](#) [SMA101](#) [SMA32](#) [SMA411](#) [SMA531](#)  
[SST12LP19E-QX6E](#) [WPM0510A](#) [HMC5929LS6TR](#) [HMC5879LS7TR](#) [HMC1087F10](#) [HMC1086](#) [HMC1016](#) [SMA1212](#) [MAX2689EWS+T](#)  
[MAAMSS0041TR](#) [MAAM37000-A1G](#) [LTC6430AIUF-15#PBF](#) [SMA70-2](#) [SMA4011](#) [A231](#) [HMC-AUH232](#) [LX5511LQ](#) [LX5511LQ-TR](#)  
[HMC7441-SX](#) [HMC-ALH310](#) [XD1001-BD-000V](#) [A4011](#)